

PS8902

1 Mbps HIGH CMR ANALOG OUTPUT TYPE, 8-PIN LSDIP PHOTOCOUPLER FOR CREEPAGE DISTANCE OF 15 mm

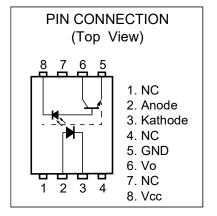
R08DS0128EJ0200 Rev. 2.00 Jun. 30, 2021

DESCRIPTION

The PS8902 is an optically coupled isolator containing an AlGaAs LED on the light emitting diode (input side) and a PIN photodiode and a high-speed amplifier transistor on the output side on one chip.

FEATURES

- Long creepage distance (15 mm MIN.)
- 8-pin LSDIP (Long Creepage SDIP) type
- High-speed response (tPHL = $0.8 \mu s$ MAX., tPLH = $1.2 \mu s$ MAX.)
- High common mode transient immunity (CM_H, CM_L = ± 15 kV/ μ s MIN.)
- Embossed tape product: PS8902-Y-F3: 1 000 pcs/reel
- Pb-Free Product
- Safety standards
 - UL approved: UL1577, Double protection
 - CSA approved: CAN/CSA-C22.2 No.62368-1, Reinforced insulation
 - VDE approved: DIN EN 60747-5-5 (Option)

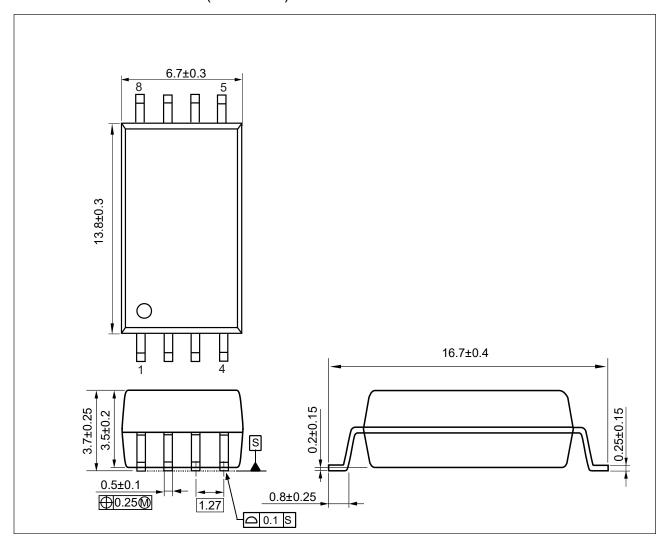


APPLICATIONS

Power supply

- · Computer and peripheral manufactures
- General purpose inverter
- Substitutions for relays and pulse transformers

PACKAGE DIMENSIONS (UNIT: mm)

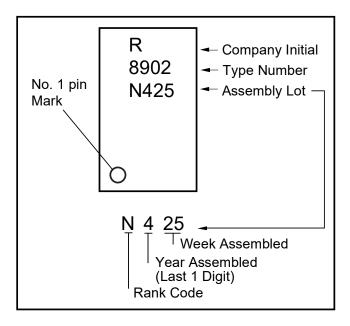


Weight: 0.642g (typ.)

PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	14.5 mm
Creepage Distance	15 mm
Isolation Distance	0.4 mm

MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS8902	PS8902-Y-AX	Pb-Free	10 pcs (Tape 10 pcs cut)	Standard products	PS8902
PS8902-F3	PS8902-Y-F3-AX	(Ni/Pd/Au)	Embossed Tape 1 000 pcs/reel	(UL, CSA approved)	
PS8902-V	PS8902-Y-V-AX		10 pcs (Tape 10 pcs cut)	UL, CSA,	
PS8902-V-F3	PS8902-Y-V-F3-AX		Embossed Tape 1 000	DIN EN60747-5-5	
			pcs/reel	approved	

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode Forward Current		l _F	25	mA
	Reverse Voltage	V _R	5.0	V
	Power Dissipation*1	P _D	45	mW
Detector	Supply Voltage	Vcc	35	V
	Output Voltage	Vo	35	V
	Output Current	lo	8.0	mA
	Power Dissipation*2	Pc	250	mW
Isolation \	/oltage ^{*3}	BV	7500	Vr.m.s.
Operating Ambient Temperature		TA	-55 to +110	°C
Storage Temperature		T _{stg}	-55 to +125	°C

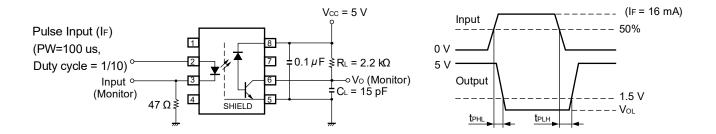
Notes *1 Reduced to 0.8 mW/°C at T_A = 85 °C or more.

- *2 Reduced to 5.2 mW/°C at T_A = 85 °C or more.
- *3 AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output. Pins 1-4 shorted together, 5-8 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

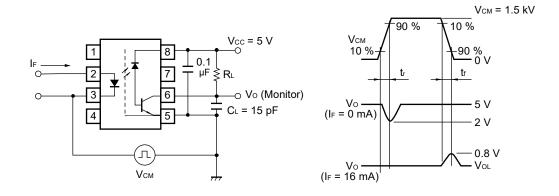
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 16 mA	1.35	1.65	1.85	V
	Reverse Current	lR	V _R = 3 V	-	-	10	μА
	Forward Voltage Temperature Coefficient	⊿V f /⊿ Ta	I _F = 16 mA	-	-2.2	-	mV/°C
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz	-	30	-	pF
Detector	High Level Output Current	Іон (1)	I _F = 0 mA, V _{CC} = V _O = 5.5 V	-	0.5	500	nA
Detector	High Level Output Current	Іон (2)	I _F = 0 mA, V _{CC} = V _O = 30 V	-	-	100	μА
	Low Level Output Voltage	Vol	IF = 16 mA, Vcc = 4.5 V, IoL = 1.2 mA	-	0.1	0.4	V
	High Level Supply Current	Іссн	I _F = 0 mA, V ₀ = open, V _{CC} = 30 V	-	0.01	2	μА
	Low Level Supply Current	Iccl	I _F = 16 mA, V _O = open, V _{CC} = 30 V	-	50	-	μА
Coupled	Current Transfer Ratio	CTR	I _F = 16 mA, V _{CC} = 4.5 V, V _O = 0.4 V	15	-	35	%
Coupled	Input-Output Isolation Resistance	R _{I-O}	V _{I-O} = 1 kV _{DC} , RH = 40 to 60%	10 ¹¹	-	-	Ω
	Input-Output Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz	-	1.0	-	pF
	Propagation Delay Time $(H \rightarrow L)^{*1}$	tрнL	I _F = 16 mA, V_{CC} = 5 V, R_L = 2.2 k Ω , C_L = 15 pF	-	0.3	0.8	μS
	Propagation Delay Time $(L \rightarrow H)^{*1}$	tрцн		-	0.5	1.2	
	Common Mode Transient Immunity at High Level Output*2	Смн	I _F = 0 mA, V _{CC} = 5 V, R _L = 4.1 kΩ, V _{CM} = 1.5 kV,Vo>2V	15	-	-	kV/μs
	Common Mode Transient Immunity at Low Level Output*2	Смь	I _F = 16 mA, V _{CC} = 5 V, R _L = 4.1 kΩ, V _{CM} = 1.5 kV, Vo<0.8V	15	-	-	

Notes *1 Test circuit for propagation delay time



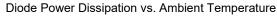
Remark C_L is approximately 15 pF which includes probe and stray wiring capacitance.

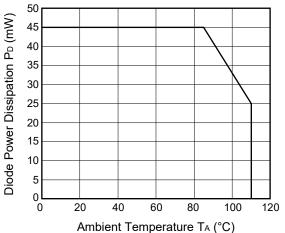
*2 Test circuit for common mode transient immunity



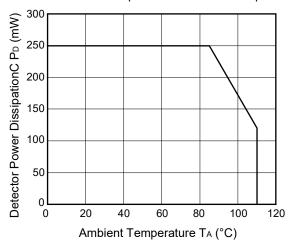
Remark C_L is approximately 15 pF which includes probe and stray wiring capacitance.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

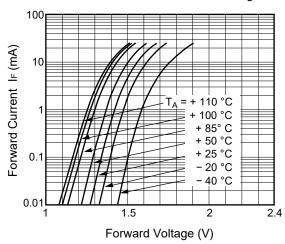




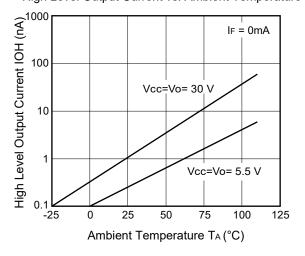
Detector Power Dissipation vs. Ambient Temperature



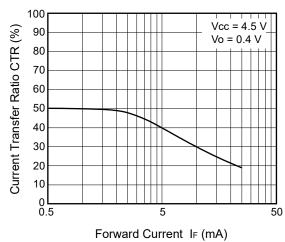
Forward Current vs. Forward Voltage



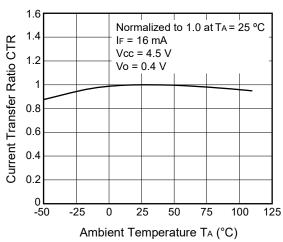
High Level Output Current vs. Ambient Temperature



Current Transfer Ratio vs. Forward Current

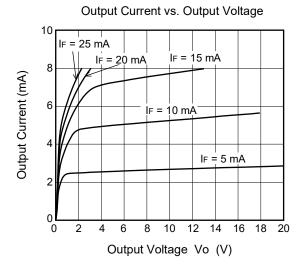


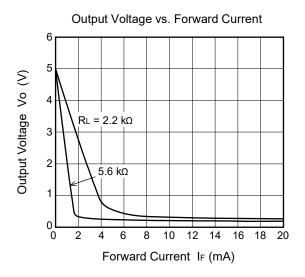
Current Transfer Ratio

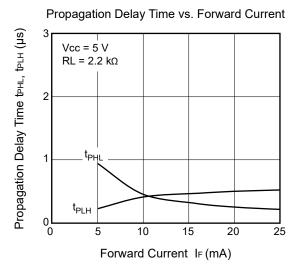


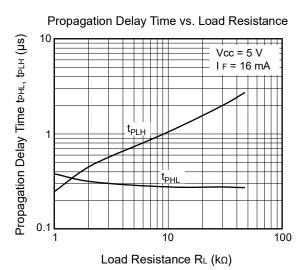
Remark The graphs indicate nominal characteristics.

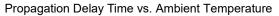
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

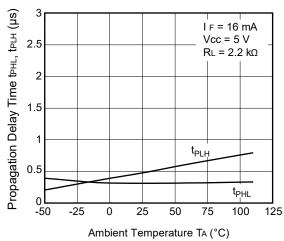






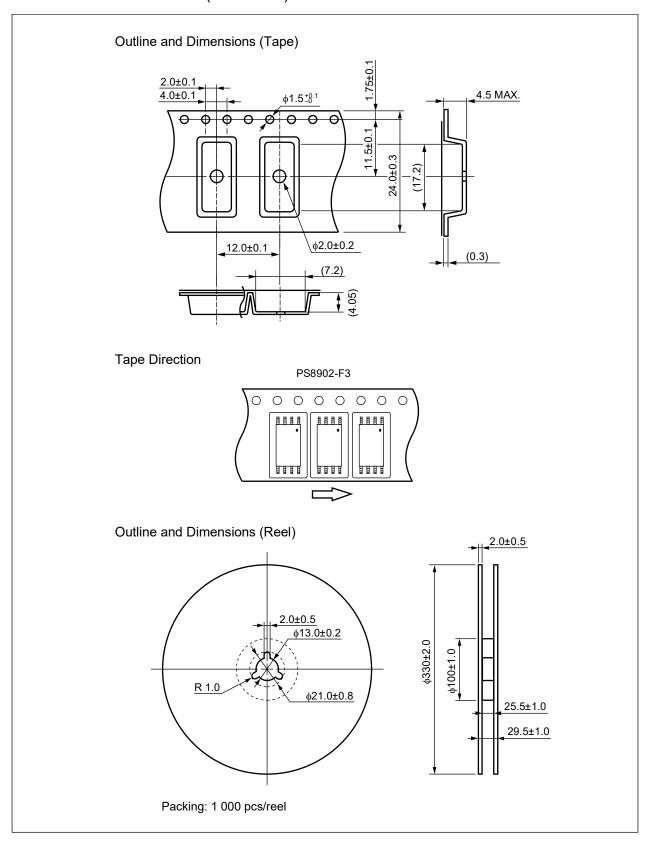




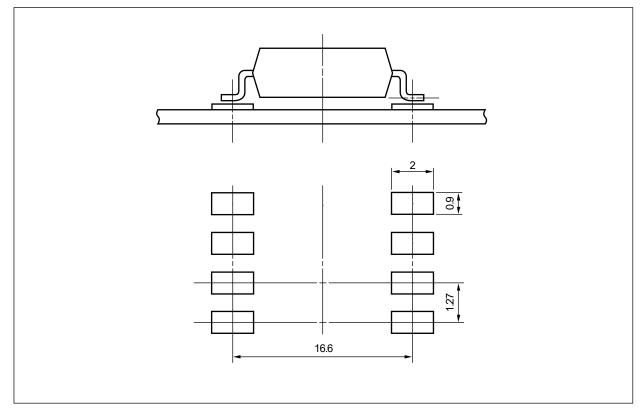


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



[8pin LSDIP]

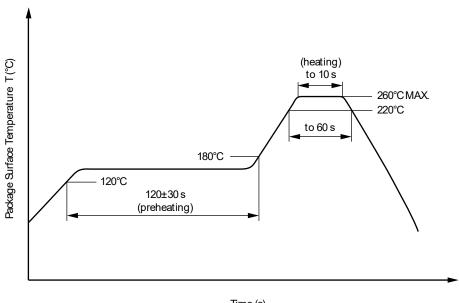
Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering
 - Peak reflow temperature
 260 °C or below (package surface temperature)
 - Time of peak reflow temperature
 Time of temperature higher than 220 °C
 60 seconds or less
 - Time to preheat temperature from 120 to 180 °C 120 ± 30 s
 - Number of reflows
 Three
 - Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

Temperature 260 °C or below (molten solder temperature)

Time 10 seconds or less

Preheating conditions 120°C or below (package surface temperature)

Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 110 °C

(4) Cautions

Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

PS8902 Data Sheet

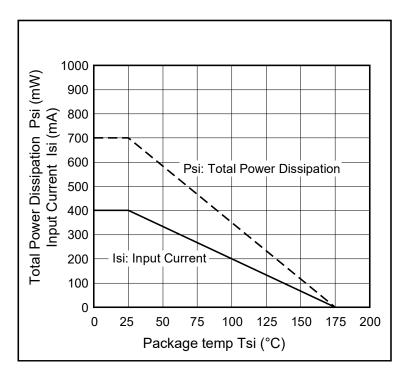
USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

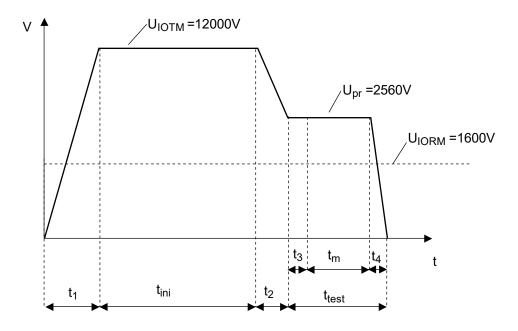
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength			
maximum operating isolation voltage	U_{IORM}	1 600	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	U_pr	2 560	V_{peak}
$U_{pr} = 1.6 \times U_{IORM.}, P_d < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	U_pr	3 000	V_{peak}
$U_{pr} = 1.875 \times U_{IORM.}, P_d < 5 pC$			
Highest permissible overvoltage	U _{ІОТМ}	12 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T_{stg}	-55 to +125	°C
Operating temperature range	TA	-40 to +110	°C
Isolation resistance, minimum value			
V _{IO} = 500 V dc at T _A = 25 °C	Ris MIN.	10 ¹²	Ω
V _{IO} = 500 V dc at T _A MAX. at least 100 °C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	175	°C
Current (input current I _F , Psi = 0)	lsi	400	mA
Power (output or total power dissipation)	Psi	700	mW
Isolation resistance			
V _{IO} = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

Dependence of maximum safety ratings with package temperature



Method a Destructive Test, Type and Sample Test



 $t_1, t_2 = 1 \text{ to } 10 \text{ sec}$

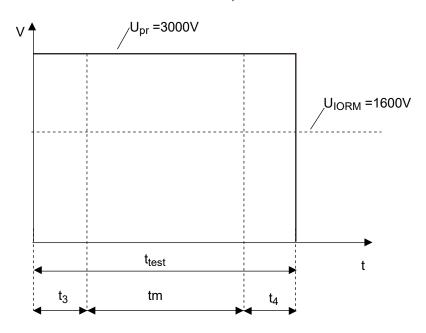
 $t_3, t_4 = 1 sec$

 $t_{m(PARTIAL\ DISCHARGE)}$ = 10 sec

 t_{test} = 12 sec

 $t_{ini} = 60 \text{ sec}$

Method b Non-destructive Test, 100 % Production Test



 $t_3, t_4 = 0.1 \text{ sec}$

 $t_{m(PARTIAL\ DISCHARGE)}$ = 1.0 sec

 $t_{test} = 1.2 \text{ sec}$

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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